

## STW12N150K5

# N-channel 1500 V, 1.6 Ω typ.,7 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

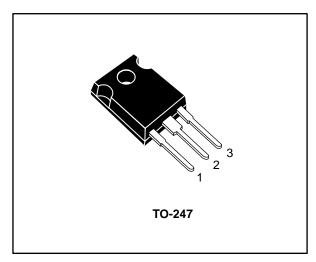
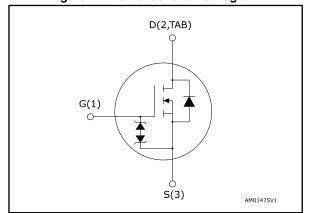


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	Ртот
STW12N150K5	1500 V	1.9 Ω	7 A	250 W

- Industry's lowest R<sub>DS(on)</sub> \* area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STW12N150K5	12N150K5	TO-247	Tube

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STW12N150K5 Electrical ratings

## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	± 30	V
$I_D$	Drain current at T <sub>C</sub> = 25 °C	7	Α
I <sub>D</sub>	Drain current at T <sub>C</sub> = 100 °C	4	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	28	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	250	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	4.5	V/ns
dv/dt <sup>(3)</sup>	/dt <sup>(3)</sup> MOSFET dv/dt ruggedness 50		V/ns
$T_{j}$	Operating junction temperature	FF to 150	°C
T <sub>stg</sub>	Storage temperature	- 55 to 150	C

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R <sub>thj-case</sub>	Thermal resistance junction-case	0.5	°C/W	
R <sub>thj-amb</sub>	Thermal resistance junction-amb	50	°C/W	

**Table 4: Avalanche characteristics** 

Symbol	Parameter		Unit	
I <sub>AR</sub>	R Max current during repetitive or single pulse avalanche			
E <sub>AS</sub>			mJ	

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>I_{SD} \le 7$  A, di/dt  $\le 100$  A/ $\mu$ s,  $V_{Peak} \le V_{(BR)DSS}$ 

<sup>&</sup>lt;sup>(3)</sup>V<sub>DS</sub> ≤ 1200 V

Electrical characteristics STW12N150K5

### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	1500			٧
	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 1500 \text{ V}$			1	μΑ
I <sub>DSS</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 1500 V, Tc=125 °C			50	μΑ
I <sub>GSS</sub>	Gate body leakage current	$V_{DS} = 0$ , $V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.5 A		1.6	1.9	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1360	-	pF
Coss	Output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V},$	-	80	ı	pF
C <sub>rss</sub>	Reverse transfer capacitance	f = 1MHz	-	0.7	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	V <sub>DS</sub> = 0 V to 1200 V,	-	82	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0 V$	-	32	-	pF
$R_{G}$	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	3	1	Ω
$Q_g$	Total gate charge	$V_{DD} = 1200 V, I_D = 7 A$	-	47	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	8	1	nC
$Q_{gd}$	Gate-drain charge	(see Figure 16: "Gate charge test circuit")	-	32	-	nC

#### Notes:

<sup>&</sup>lt;sup>(1)</sup>Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

 $<sup>^{(2)}</sup>$  Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDS increases from 0 to 80% VDSS.

**Table 7: Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}$ = 750 V, $I_{D}$ = 3.5 A, $R_{G}$ = 4.7 $\Omega$ $V_{GS}$ = 10 V (see Figure 18: "Unclamped inductive load test circuit")	-	25	-	ns
t <sub>r</sub>	Rise time		-	8	-	ns
t <sub>d(off)</sub>	Turn-off delay time		1	90	-	ns
t <sub>f</sub>	Fall time		-	37	-	ns

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		7	Α
I <sub>SDM</sub>	Source-drain current (pulsed)		-		28	А
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 7 A, V <sub>GS</sub> = 0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$	-	302		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs,  (see Figure 17: "Test circuit for inductive load switching and diode recovery times")	-	3.71		μC
I <sub>RRM</sub>	Reverse recovery current		-	24.6		А
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$ $di/dt = 100 \text{ A/}\mu\text{s},$ Tj = 150  °C (see Figure 17: "Test circuit for	-	432		ns
Q <sub>rr</sub>	Reverse recovery charge		-	4.71		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	21.8		А

#### Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V(BR)GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	,	-	V

The built-in back-to-back Zener diodes have been specifically designed to enhance the ESD capability of the device. The Zener voltage is appropriate for efficient and cost-effective intervention to protect the device integrity. These integrated Zener diodes thus eliminate the need for external components.



 $<sup>^{(1)}</sup>$ Pulsed: pulse duration = 300 $\mu$ s, duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

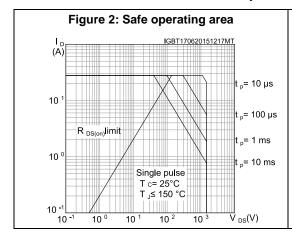


Figure 3: Thermal impedance

K

0-0.5

0.2

10<sup>-1</sup>

0.05

0.02

10<sup>-2</sup>

Single pulse

2t<sub>II</sub>= K<sup>\*</sup>R thj.c

5 t t<sub>P</sub>/T

10<sup>-3</sup>

10<sup>-5</sup>

10<sup>-4</sup>

10<sup>-3</sup>

10<sup>-2</sup>

10<sup>-1</sup>

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10<sup>-3</sup>

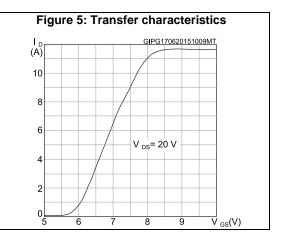
Figure 4: Output characteristics

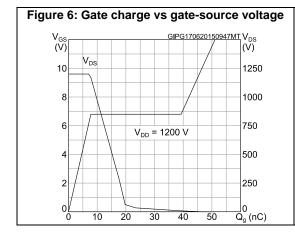
(A)

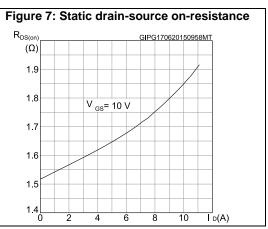
V<sub>GS</sub> = 10 V
V<sub>GS</sub> = 9 V

V<sub>GS</sub> = 7 V

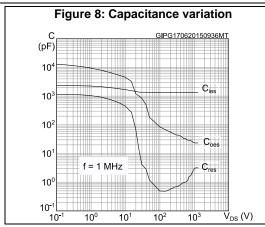
V<sub>GS</sub> = 6 V
0
0
4
8
12
16
V<sub>DS</sub> (V)







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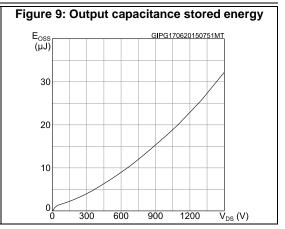


Figure 10: Normalized gate threshold voltage vs temperature

V<sub>GS(th)</sub>
(norm.)

1.2

1

0.8

0.6

0.4

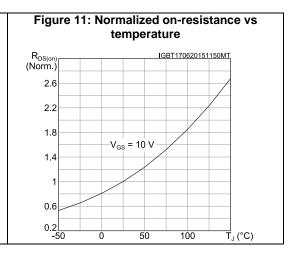
0.2

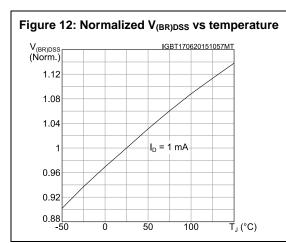
-50

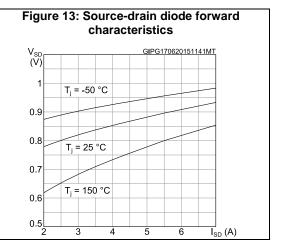
0 50

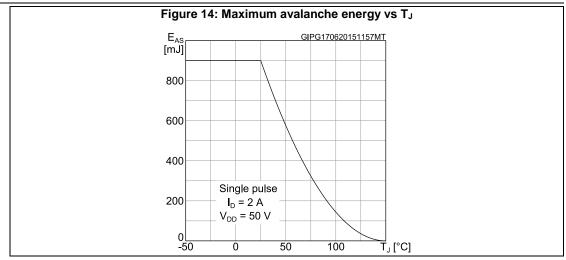
100

T<sub>j</sub> (°C)



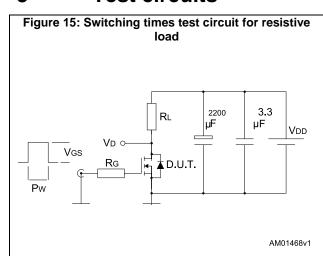


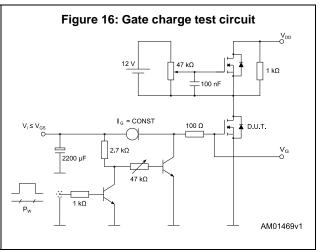


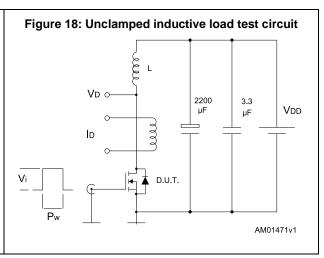


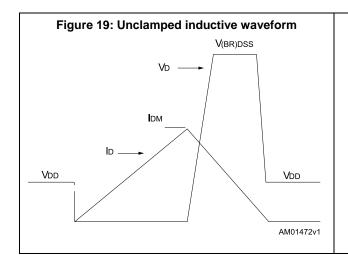
STW12N150K5 Test circuits

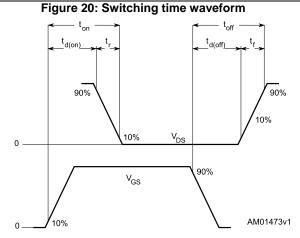
### 3 Test circuits













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## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

### 4.1 TO-247 package information

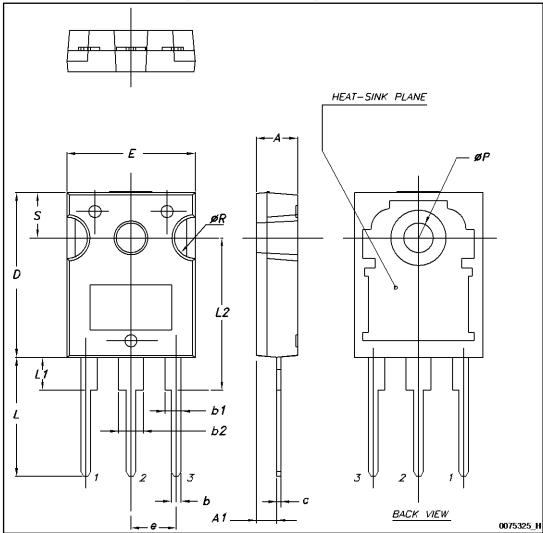


Figure 21: TO-247 package outline

Table 10: TO-247 package mechanical data

		mm.	
Dim.	Min.	Тур.	Max.
A	4.85	71	5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Revision history STW12N150K5

## 5 Revision history

Table 11: Document revision history

Date	Revision	Changes
11-May-2015	1	First release.
30-Jun-2015	2	Updated title and features in cover page. Updated Section 4: "Electrical ratings", Section 5: "Electrical characteristics".  Added Section 5.1: "Electrical characteristics (curves)".  Minor text changes.
07-Jul-2015	3	Updated Section 5.1: "Electrical characteristics (curves)".  Minor text changes.

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